

Product Order Codes



For ordering of products, then name is specified according to the following convention:
Wmxxxxyztp/RV.

This is decoded as (lower case letters indicate more than one option):

WM	Wolfson Part Indicator
xxxx	Part Number
y	Optional Performance Indicator
z	Lead Free Option
t	Temperature Grade
p	Package (See Following Table)
/R	Tape and Reel (Optional)
/V	Dry Baked and Vacuum Packed (Dependent on Package Type)

The manufacturing code is specified according the following convention: YMTTABC.
This is decoded as:

Y = Year (Last Digit of Year)

M = Month ((1-9, A, B, C)

TT = Lot Trace Code. AA to ZZ, Starts with AA, Increments for Each Batch

ABC = Unique Code for Identification of Foundry, Assembly Site, Test Location



Product Order Codes

Lead Free Decoding Options

- S Lead free, not green mold compound
- G Lead free, green mold compound

Temperature Decoding Options

- C Commercial 0 to 70 deg C
- E Extended (any other range specified in the data sheet)
- I Industrial -40 to +85 deg C
- M Military -55 to +125 deg C

Package Decoding Options

- P 8-pin plastic dual in line (PDIP)
- N > 8-pin plastic dual in line (PDIP)
- D Plastic small outline IC (SOIC)
- DW Wide body plastic small outline (SOIC)
- DS Plastic shrink small outline IC (SSOP)
- DT Plastic thin shrink small outline IC (TSSOP)
- FL Plastic quad flat pack no leads (QFN)
- FR Regular quad flat pack styles (QFP)
- FT Thin quad flat pack styles (TQFP)
- FC Ceramic quad flat pack (CERQUAD)
- B Ball grid array (BGA)
- Y Un-packaged. In die form only

Packing Method

- /R Tape and Reel (Optional)
- /V Dry baked and vacuum packed (dependent on package type)